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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









## 2A, 50V - 1000V Surface Mount Rectifiers

#### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition







DO-214AC (SMA)

#### **MECHANICAL DATA**

Case: DO-214AC (SMA)

Molding compound, UL flammability classification rating 94V-0

Moisture sensitivity level: level 1, per J-STD-020 Part no. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 2 whisker test **Polarity:** Indicated by cathode band **Weight:** 0.06 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)									
PARAMETER	SYMBOL	S2	S2	S2	S2	S2	S2	S2	UNIT
PARAMETER	STWBOL	AA	ВА	DA	GA	JA	KA	MA	
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	1.5					Α		
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	50			А				
Maximum instantaneous forward voltage (Note 1) @ 1.5 A	V <sub>F</sub>	1.1				V			
Maximum reverse current @ rated $V_R$ $T_J$ =25°C $T_J$ =125°C	I <sub>R</sub>	5 125			μΑ				
Typical reverse recovery time (Note 2)	t <sub>rr</sub>	1.5						μs	
Typical junction capacitance (Note 3)	CJ				30				pF
Typical thermal resistance	$R_{ hetaJL}$ $R_{ hetaJA}$				°C/W				
Operating junction temperature range	TJ	- 55 to +150					°C		
Storage temperature range	T <sub>STG</sub>	- 55 to +150					°C		

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Reverse Recovery Test Conditions:  $I_F$ =0.5A,  $I_R$ =1.0A,  $I_{RR}$ =0.25A

Note 3: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.

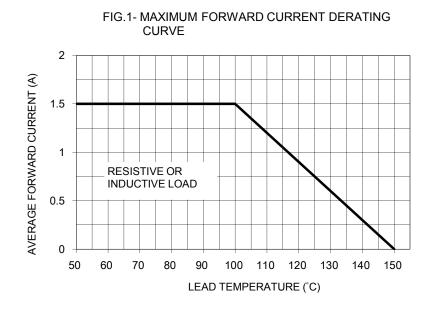


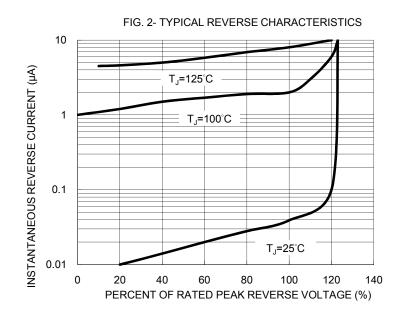
RDERIN	IG INFORMATI	ON			
PART	PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING
NO.	SUFFIX		SUFFIX		
		R3		SMA	1,800 / 7" Plastic reel
		R2		SMA	7,500 / 13" Paper reel
S2xA	Ш	M2	0	SMA	7,500 / 13" Plastic reel
(Note 1)	Н	F3	G	Folded SMA	1,800 / 7" Plastic reel
		F2		Folded SMA	7,500 / 13" Paper reel
		F4		Folded SMA	7,500 / 13" Plastic reel

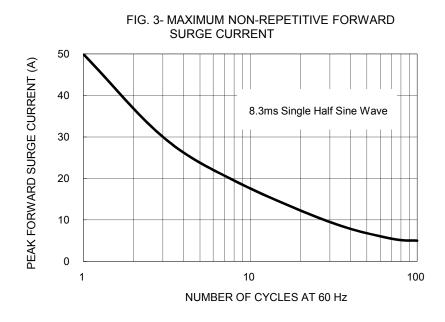
Note 1: "x" defines voltage from 50V (S2AA) to 1000V (S2MA)

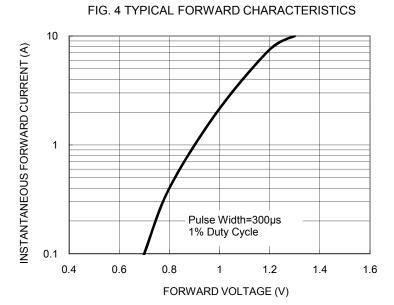
EXAMPLE					
PREFERRED PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
S2MAHR3G	S2MA	Н	R3	G	AEC-Q101 qualified Green compound

#### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub>=25°C unless otherwise noted)









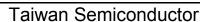
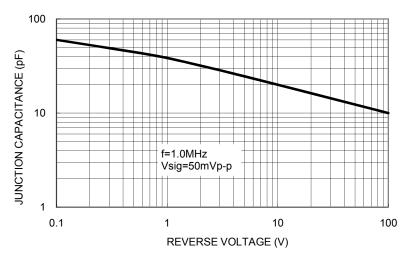
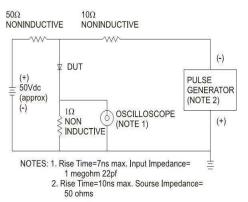


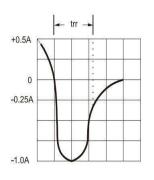


FIG. 5 TYPICAL JUNCTION CAPACITANCE

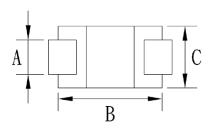


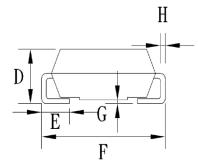
#### FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





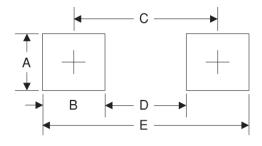
# PACKAGE OUTLINE DIMENSIONS DO-214AC (SMA)





DIM.	Unit (mm)		Unit (inch)		
DIIVI.	Min	Min Max Min		Max	
Α	1.27	1.58	0.050	0.062	
В	4.06	4.60	0.160	0.181	
С	2.29	2.83	0.090	0.111	
D	1.99	2.50	0.078	0.098	
Е	0.90	1.41	0.035	0.056	
F	4.95	5.33	0.195	0.210	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

## SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

### **MARKING DIAGRAM**



P/N = Specific Device Code
G = Green Compound
YW = Date Code
F = Factory Code



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